

# **CD4076BMS**

December 1992

# **CMOS 4 -Bit D-Type Registers**

#### **Features**

- High Voltage Type (20V Rating)
- Three State Outputs
- · Input Disabled Without Gating the Clock
- Gated Output Control Lines for Enabling or Disabling the Outputs
- Standardized Symmetrical Output Characteristics
- 100% Tested for Quiescent Current at 20V
- Maximum Input Current of 1μA at 18V Over Full Package Temperature Range; 100nA at 18V and +25°C
- Noise Margin (Over Full Package/Temperature Range)
  - 1V at VDD = 5V
  - 2V at VDD = 10V
  - 2.5V at VDD = 15V
- 5V, 10V and 15V Parametric Ratings
- Meets All Requirements of JEDEC Tentative Standard No. 13B, "Standard Specifications for Description of 'B' Series CMOS Devices"

# Description

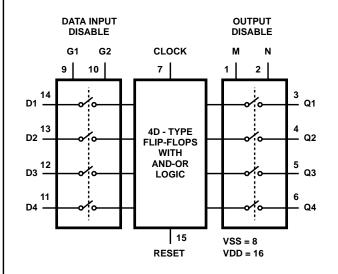
CD4076BMS types are four-bit registers consisting of D-type flip-flops that feature three-state outputs. Data Disable inputs are provided to control the entry of data into the flip-flops. When both Data Disable inputs are low, data at the D inputs are loaded into their respective flip-flops on the next positive transition of the clock input. Output Disable inputs are also provided. When the Output Disable inputs are both low, the normal logic states of the four outputs are available to the load. The outputs are disabled independently of the clock by a high logic level at either Output Disable input, and present a high impedance.

The CD4076BMS is supplied in these 16 lead outline packages:

Braze Seal DIP H4T
Frit Seal DIP H1E
Ceramic Flatpack H6W

#### **Pinout CD4076BMS TOP VIEW** 16 VDD OUTPUT DISABLE 15 RESET Q1 14 DATA 1 13 DATA 2 Q3 12 DATA 3 11 DATA 4 Q4 6 10 G2) DATA CLOCK 7 9 G1 ∫ DISABLE vss 8

# Functional Diagram



#### **Reliability Information Absolute Maximum Ratings** Ceramic DIP and FRIT Package . . . . $\theta_{ja}$ Flatnack Package . . . . 80°C/W DC Supply Voltage Range, (VDD) . . . . . -0.5V to +20V Thermal Resistance ..... $_{20^{o}\text{C/W}}^{\theta_{jc}}$ (Voltage Referenced to VSS Terminals) Input Voltage Range, All Inputs . . . . . . . -0.5V to VDD +0.5V Flatpack Package ...... 70°C/W 20°C/W Maximum Package Power Dissipation (PD) at +125°C DC Input Current, Any One Input .....±10mA Operating Temperature Range.....-55°C to +125°C For TA = $-55^{\circ}$ C to $+100^{\circ}$ C (Package Type D, F, K).....500mW Package Types D, F, K, H For TA = $+100^{\circ}$ C to $+125^{\circ}$ C (Package Type D, F, K) . . . . . Derate Storage Temperature Range (TSTG) . . . . . . . -65°C to +150°C Linearity at 12mW/°C to 200mW Lead Temperature (During Soldering) . . . . . . . . +265°C Device Dissipation per Output Transistor . . . . . . . . . . . . . . . . 100mW For TA = Full Package Temperature Range (All Package Types) At Distance 1/16 $\pm$ 1/32 Inch (1.59mm $\pm$ 0.79mm) from case for 10s Maximum

#### TABLE 1. DC ELECTRICAL PERFORMANCE CHARACTERISTICS

				GROUP A		LIM	IITS	
PARAMETER	SYMBOL	CONDITIONS (1	NOTE 1)	SUBGROUP S	TEMPERATURE	MIN	MAX	UNIT S
Supply Current	IDD	VDD = 20V, VIN = VD	D or GND	1	+25°C	-	10	μΑ
				2	+125°C	-	1000	μA
		VDD = 18V, VIN = VD	D or GND	3	-55°C	-	10	μΑ
Input Leakage Current	IIL	VIN = VDD or GND	VDD = 20	1	+25°C	-100	-	nA
				2	+125°C	-1000	-	nA
			VDD = 18V	3	-55°C	-100	-	nA
Input Leakage Current	IIH	VIN = VDD or GND	VDD = 20	1	+25°C	-	100	nA
				2	+125°C	-	1000	nA
			VDD = 18V	3	-55°C	-	100	nA
Output Voltage	VOL15	VDD = 15V, No Load	VDD = 15V, No Load		+25°C, +125°C, - 55°C	-	50	mV
Output Voltage	VOH15	VDD = 15V, No Load	(Note 3)	1, 2, 3	+25°C, +125°C, - 55°C	14.95	-	V
Output Current (Sink)	IOL5	VDD = 5V, VOUT = 0.4V		1	+25°C	0.53	-	mΑ
Output Current (Sink)	IOL10	VDD = 10V, VOUT = 0.5V		1	+25°C	1.4	-	mA
Output Current (Sink)	IOL15	VDD = 15V, VOUT = 1.5V		1	+25°C	3.5	-	mΑ
Output Current (Source)	IOH5A	VDD = 5V, VOUT = 4.6V		1	+25°C	-	-0.53	mA
Output Current (Source)	IOH5B	VDD = 5V, VOUT = 2.5V		1	+25°C	-	-1.8	mA
Output Current (Source)	IOH10	VDD = 10V, VOUT = 9	9.5V	1	+25°C	-	-1.4	mA
Output Current (Source)	IOH15	VDD = 15V, VOUT =	13.5V	1	+25°C	-	-3.5	mA
N Threshold Voltage	VNTH	VDD = 10V, ISS = -10	)μΑ	1	+25°C	-2.8	-0.7	V
P Threshold Voltage	VPTH	VSS = 0V, IDD = 10μ	A	1	+25°C	0.7	2.8	V
Functional	F	VDD = 2.8V, VIN = VI	DD or GND	7	+25°C	VOH>	VOL	V
		VDD = 20V, VIN = VD	D or GND	7	+25°C	VDD/2	<	
		VDD = 18V, VIN = VD	D or GND	8A	+125°C	1	VDD/2	
		VDD = 3V, VIN = VDD	or GND	8B	-55°C	1		
Input Voltage Low (Note 2)	VIL	VDD = 5V, VOH > 4.5	V, VOL < 0.5V	1, 2, 3	+25°C, +125°C, - 55°C	-	1.5	V
Input Voltage High (Note 2)	VIH	VDD = 5V, VOH > 4.5	V, VOL < 0.5V	1, 2, 3	+25°C, +125°C, - 55°C	3.5	-	V
Input Voltage Low (Note 2)	VIL	VDD = 15V, VOH > 13.5V, VOL < 1.5V		1, 2, 3	+25°C, +125°C, - 55°C	-	4	V
Input Voltage High (Note 2)	VIH	VDD = 15V, VOH > 13 VOL < 1.5V	3.5V,	1, 2, 3	+25°C, +125°C, - 55°C	11	-	V
Tri-State Output	IOZL	VIN = VDD or GND	VDD = 20V	1	+25°C	-0.4	-	μΑ
Leakage		VOUT = 0V		2	+125°C	-12	-	μA
			VDD = 18V	3	-55°C	-0.4	-	μA

TABLE 1. DC ELECTRICAL PERFORMANCE CHARACTERISTICS

		CONDITIONS (NOTE 1)		GROUP A		LIMITS		<b></b>
PARAMETER	SYMBOL			SUBGROUP S	TEMPERATURE	MIN	MAX	UNIT S
Tri-State Output	IOZH	VIN = VDD or GND	VDD = 20V	1	+25°C	-	0.4	μΑ
Leakage		VOUT = VDD	'DD	2	+125°C	-	12	μΑ
			VDD = 18V	3	-55°C	-	0.4	μΑ

NOTES: 1. All voltages referenced to device GND, 100% testing being 3. For accuracy, voltage is measured differentially to VDD. implemented.

Limit is 0.050V max.

2. Go/No Go test with limits applied to inputs.

#### TABLE 2. AC ELECTRICAL PERFORMANCE CHARACTERISTICS

			GROUP A		LIM		
PARAMETER	SYMBOL	CONDITIONS (Notes 1, 2)	SUBGROUPS	TEMPERATURE	MIN	MAX	UNITS
Propagation Delay	TPHL	VDD = 5V, VIN = VDD or GND	9	+25°C	-	600	ns
Clock to Q Output	TPLH		10, 11	+125°C, -55°C	-	810	ns
Transition Time	TTHL	VDD = 5V, VIN = VDD or GND	9	+25°C	-	200	ns
	TTLH	l	10, 11	+125°C, -55°C	-	270	ns

#### NOTES:

- 1. CL = 50pF, RL = 200K, Input TR, TF < 20ns.
- 2. -55°C and +125°C limits guaranteed, 100% testing being implemented.

TABLE 3. ELECTRICAL PERFORMANCE CHARACTERISTICS

					LIN	IITS	
PARAMETER	SYMBOL	CONDITIONS	NOTES	TEMPERATURE	MIN	MAX	UNITS
Supply Current	IDD	VDD = 5V, VIN = VDD or GND	1, 2	-55°C, +25°C	-	5	μΑ
				+125°C	-	150	μΑ
		VDD = 10V, VIN = VDD or GND	1, 2	-55°C, +25°C	-	10	μΑ
				+125°C	-	300	μΑ
		VDD = 15V, VIN = VDD or GND	1, 2	-55°C, +25°C	-	10	μΑ
				+125°C	-	600	μΑ
Output Voltage	VOL	VDD = 5V, No Load	1, 2	+25°C, +125°C, -55°C	-	50	mV
Output Voltage	VOL	VDD = 10V, No Load	1, 2	+25°C, +125°C, -55°C	-	50	mV
Output Voltage	VOH	VDD = 5V, No Load	1, 2	+25°C, +125°C, -55°C	4.95	-	V
Output Voltage	VOH	VDD = 10V, No Load	1, 2	+25°C, +125°C, -55°C	9.95	-	V
Output Current (Sink)	IOL5	VDD = 5V, VOUT = 0.4V	1, 2	+125°C	0.36	-	mA
				-55°C	0.64	-	mA
Output Current (Sink)	IOL10	VDD = 10V, VOUT = 0.5V	1, 2	+125°C	0.9	-	mA
				-55°C	1.6	-	mA
Output Current (Sink)	IOL15	VDD = 15V, VOUT = 1.5V	1, 2	+125°C	2.4	-	mA
				-55°C	4.2	-	mA
Output Current (Source)	IOH5A	VDD = 5V, VOUT = 4.6V	1, 2	+125°C	-	-0.36	mA
				-55°C	-	-0.64	mA
Output Current (Source)	IOH5B	VDD = 5V, VOUT = 2.5V	1, 2	+125°C	-	-1.15	mA
				-55°C	-	-2.0	mA
Output Current (Source)	IOH10	VDD = 10V, VOUT = 9.5V	1, 2	+125°C	-	-0.9	mA
				-55°C	-	-2.6	mA

TABLE 3. ELECTRICAL PERFORMANCE CHARACTERISTICS (Continued)

					LIN	IITS	
PARAMETER	SYMBOL	CONDITIONS	NOTES	TEMPERATURE	MIN	MAX	UNITS
Output Current (Source)	IOH15	VDD =15V, VOUT = 13.5V	1, 2	+125°C	-	-2.4	mA
				-55°C	-	-4.2	mA
Input Voltage Low	VIL	VDD = 10V, VOH > 9V, VOL < 1V	1, 2	+25°C, +125°C, -55°C	-	3	V
Input Voltage High	VIH	VDD = 10V, VOH > 9V, VOL < 1V	1, 2	+25°C, +125°C, -55°C	7	-	V
Propagation Delay	TPHL1	VDD = 10V	1, 2, 3	+25°C	-	250	ns
Clock to Q Output	TPLH1	VDD = 15V	1, 2, 3	+25°C	-	180	ns
Propagation Delay	TPHL2	PHL2 VDD = 5V		+25°C	-	460	ns
Reset		VDD = 10V	1, 2, 3	+25°C	-	200	ns
		VDD = 15V	1, 2, 3	+25°C	-	150	ns
Propagation Delay	TPHZ	VDD = 5V	1, 2, 4	+25°C	-	300	ns
3 - State	TPLZ	VDD = 10V	1, 2, 4	+25°C	-	150	ns
		VDD = 15V	1, 2, 4	+25°C	-	120	ns
Propagation Delay	TPZH	VDD = 5V	1, 2, 4	+25°C	-	300	ns
3 - State	TPZL	VDD = 10V	1, 2, 4	+25°C	-	150	ns
		VDD = 15V	1, 2, 4	+25°C	-	120	ns
Transition Time	TTHL	VDD = 10V	1, 2, 3	+25°C	-	100	ns
	TTLH	VDD = 15V	1, 2, 3	+25°C	-	80	ns
Transition Time	TTLH	VDD = 10V	1, 2, 3	+25°C	-	-	ns
		VDD = 15V	1, 2, 3	+25°C	-	-	ns
Maximum Clock Input	FCL	VDD = 5V	1, 2, 3	+25°C	3	-	MHz
Frequency		VDD = 10V	1, 2, 3	+25°C	6	-	MHz
		VDD = 15V	1, 2, 3	+25°C	8	-	MHz
Minimum Data Setup	TS	VDD = 5V	1, 2, 3	+25°C	-	200	ns
Time		VDD = 10V	1, 2, 3	+25°C	-	80	ns
		VDD = 15V	1, 2, 3	+25°C	-	60	ns
Minimum Data Hold Time	TW	VDD = 5V	1, 2, 3	+25°C	-	120	ns
Reset Pulse Width		VDD = 10V	1, 2, 3	+25°C	-	50	ns
		VDD = 15V	1, 2, 3	+25°C	-	40	ns
Minimum Clock Pulse	TW	VDD = 5V	1, 2, 3	+25°C	-	200	ns
Width		VDD = 10V	1, 2, 3	+25°C	-	100	ns
		VDD = 15V	1, 2, 3	+25°C	-	80	ns
Minimum Data Input Set-	TS	VDD = 5V	1, 2, 3	+25°C	-	180	ns
Up Time		VDD = 10V	1, 2, 3	+25°C	-	100	ns
		VDD = 15V	1, 2, 3	+25°C	-	70	ns
Maximum Clock Input	TRCL	VDD = 5V	1, 2, 3, 5	+25°C	-	15	μs
Rise and Fall Time	TFCL	VDD = 10V	1, 2, 3, 5	+25°C	-	5	μs
		VDD = 15V	1, 2, 3, 5	+25°C	-	5	μs
Input Capacitance	CIN	Any Input	1, 2	+25°C	-	7.5	pF

#### TABLE 3. ELECTRICAL PERFORMANCE CHARACTERISTICS (Continued)

						LIMITS		
PARAM	METER	SYMBOL	CONDITIONS	NOTES	TEMPERATURE	MIN	MAX	UNITS

#### NOTES:

- 1. All voltages referenced to device GND.
- 2. The parameters listed on Table 3 are controlled via design or process and are not directly tested. These parameters are characterized on initial design release and upon design changes which would affect these characteristics.
- 3. CL = 50pF, RL = 200K, Input TR, TF < 20ns.
- 4. CL = 50pF, RL = 1K, Input TR, TF < 20ns.
- 5. If more than one unit is cascaded, TRCL should be made less than or equal to the sum of the transition time and the fixed propagation delay of the output of the driving stage for the estimated capacitive load.

TABLE 4. POST IRRADIATION ELECTRICAL PERFORMANCE CHARACTERISTICS

					LIMITS		
PARAMETER	SYMBOL	CONDITIONS	NOTES	TEMPERATURE	MIN	MAX	UNITS
Supply Current	IDD	VDD = 20V, VIN = VDD or GND	1, 4	+25°C	-	25	μΑ
N Threshold Voltage	VNTH	VDD = 10V, ISS = -10μA	1, 4	+25°C	-2.8	-0.2	V
N Threshold Voltage Delta	ΔVTN	VDD = 10V, ISS = -10μA	1, 4	+25°C	-	±1	V
P Threshold Voltage	VTP	VSS = 0V, IDD = 10μA	1, 4	+25°C	0.2	2.8	V
P Threshold Voltage Delta	ΔVTP	VSS = 0V, IDD = 10μA	1, 4	+25°C	-	±1	V
Functional	F	VDD = 18V, VIN = VDD or GND	1	+25°C	VOH >	VOL <	V
		VDD = 3V, VIN = VDD or GND			VDD/2	VDD/2	
Propagation Delay Time	TPHL TPLH	VDD = 5V	1, 2, 3, 4	+25°C	-	1.35 x +25°C Limit	ns

NOTES: 1. All voltages referenced to device GND.

3. See Table 2 for +25°C limit.

2. CL = 50pF, RL = 200K, Input TR, TF < 20ns.

4. Read and Record

TABLE 5. BURN-IN AND LIFE TEST DELTA PARAMETERS +25°C

PARAMETER	SYMBOL	DELTA LIMIT
Supply Current - MSI-2	IDD	± 1.0μA
Output Current (Sink)	IOL5	± 20% x Pre-Test Reading
Output Current (Source)	IOH5A	± 20% x Pre-Test Reading

#### **TABLE 6. APPLICABLE SUBGROUPS**

CONFORM	CONFORMANCE GROUP		GROUP A SUBGROUPS	READ AND RECORD
Initial Test (Pre	Initial Test (Pre Burn-In)		1, 7, 9	IDD, IOL5, IOH5A
Interim Test 1 (	Interim Test 1 (Post Burn-In)		1, 7, 9	IDD, IOL5, IOH5A
Interim Test 2 (	Post Burn-In)	100% 5004	1, 7, 9	IDD, IOL5, IOH5A
PDA (Note 1)		100% 5004	1, 7, 9, Deltas	
Interim Test 3 (	Interim Test 3 (Post Burn-In)		1, 7, 9	IDD, IOL5, IOH5A
PDA (Note 1)	)	100% 5004	1, 7, 9, Deltas	
Final Test		100% 5004	2, 3, 8A, 8B, 10, 11	
Group A		Sample 5005	1, 2, 3, 7, 8A, 8B, 9, 10, 11	
Group B	Subgroup B-5	Sample 5005	1, 2, 3, 7, 8A, 8B, 9, 10, 11, Deltas	Subgroups 1, 2, 3, 9, 10, 11
	Subgroup B-6	Sample 5005	1, 7, 9	
Group D		Sample 5005	1, 2, 3, 8A, 8B, 9	Subgroups 1, 2 3

NOTE: 1.5% Parameteric, 3% Functional; Cumulative for Static 1 and 2.

**TABLE 7. TOTAL DOSE IRRADIATION** 

	MIL-STD-883 TEST		READ AND RECORD		
CONFORMANCE GROUPS	METHOD	PRE-IRRAD	POST-IRRAD	PRE-IRRAD	POST-IRRAD
Group E Subgroup 2	5005	1, 7, 9	Table 4	1, 9	Table 4

TABLE 8. BURN-IN AND IRRADIATION TEST CONNECTIONS

					OSCILLATOR	
FUNCTION	OPEN	GROUND	VDD	9V $\pm$ -0.5V	50kHz	25kHz
Static Burn-In 1 Note 1	3 - 6	1, 2, 7 - 15	16			
Static Burn-In 2 Note 1	3 - 6	8	1, 2, 7, 9 -16			
Dynamic Burn-In Note 1	-	1, 2, 8 - 10, 15	16	3 - 6	7	11 - 14
Irradiation (Note 2)	3 - 6	8	1, 2, 7, 9 - 16			

#### NOTE:

- 1. Each pin except VDD and GND will have a series resistor of 10K  $\pm$  5%, VDD = 18V  $\pm$  0.5V
- 2. Each pin except VDD and GND will have a series resistor of  $47K \pm 5\%$ ; Group E, Subgroup 2, sample size is 4 dice/wafer, 0 failures, VDD =  $10V \pm 0.5V$

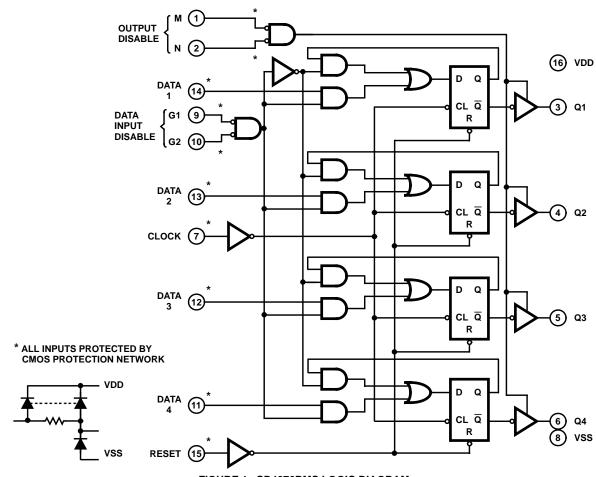


FIGURE 1. CD4076BMS LOGIC DIAGRAM

#### TRUTH TABLE

		DATA INPU	IT DISABLE	DATA	NEXT STATE OUTPUT	
RESET	CLOCK	G1	G2	D	Q	
1	Х	Х	X	X	0	
0	0	Х	Х	Х	Q	NC
0		1	Х	Х	Q	NC
0		Х	1	Х	Q	NC
0		0	0	1	1	
0		0	0	0	0	
0	1	Х	Х	Х	Q	NC
0		Х	Х	Х	Q	NC

When either Output Disable M or N is high, the outputs are disabled (high impedance state), however sequential operation of the flip-flops is not affected

1 = High Level

X = Don't Care

0 = Low Level

NC = No Change

# **Typical Performance Characteristics**

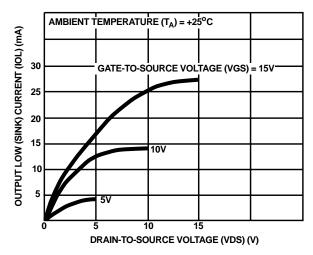
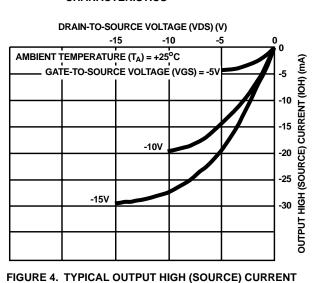


FIGURE 2. TYPICAL OUTPUT LOW (SINK) CURRENT CHARACTERISTICS



**CHARACTERISTICS** 

AMBIENT TEMPERATURE (T<sub>A</sub>) = +25°C

GATE-TO-SOURCE VOLTAGE (VGS) = 15V

10.0

7.5

10V

7.5

5.0

5V

DRAIN-TO-SOURCE VOLTAGE (VDS) (V)

FIGURE 3. MINIMUM OUTPUT LOW (SINK) CURRENT CHARACTERISTICS

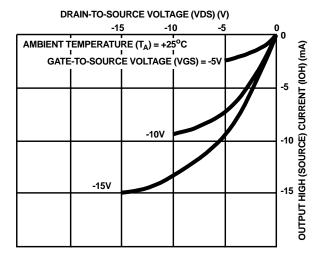
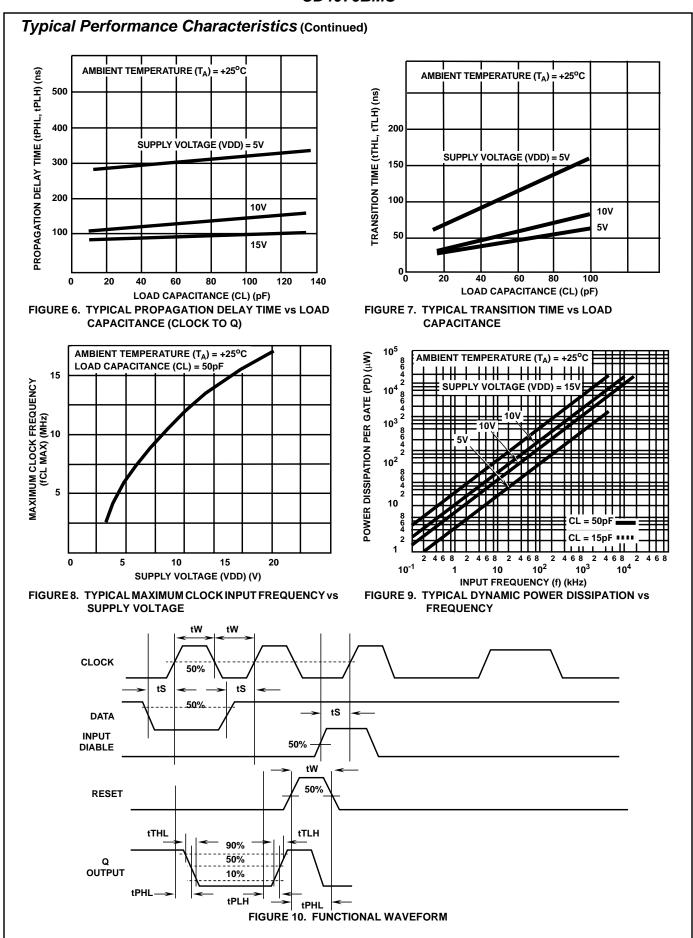
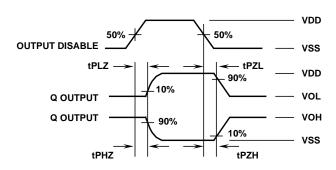


FIGURE 5. MINIMUM OUTPUT HIGH (SOURCE) CURRENT CHARACTERISTICS

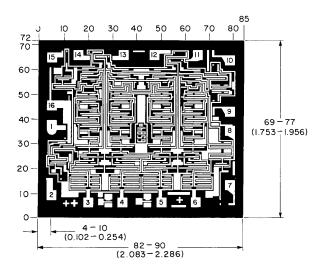




	TEST	VOLTAGE
CHARACTER	AT D	AT Q
tPHZ	VDD	VSS
tPLZ	VSS	VDD
tPZL	VSS	VDD
tPZH	VDD	VSS

FIGURE 11. FUNCTIONAL WAVEFORM

## Chip Dimensions and Pad Layout



Dimensions in parentheses are in millimeters and are derived from the basic inch dimensions as indicated. Grid graduations are in mils (10<sup>-3</sup> inch)

METALLIZATION: Thickness: 11kÅ - 14kÅ, AL.

PASSIVATION: 10.4kÅ - 15.6kÅ, Silane

**BOND PADS:** 0.004 inches X 0.004 inches MIN **DIE THICKNESS:** 0.0198 inches - 0.0218 inches

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#### **ASIA**

Intersil (Taiwan) Ltd.
Taiwan Limited
7F-6, No. 101 Fu Hsing North Road
Taipei, Taiwan
Republic of China

TEL: (886) 2 2716 9310 FAX: (886) 2 2715 3029